

Vishay Siliconix

# N-Channel 60 V (D-S) MOSFET



PRODUCT SUMMARY				
V <sub>DS</sub> (V)	60			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.0185			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 7.5 \text{ V}$	0.0225			
Q <sub>g</sub> typ. (nC)	6.9			
I <sub>D</sub> (A) <sup>a, f</sup>	16			
Configuration	Single			

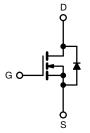
#### **FEATURES**

- TrenchFET® Gen IV power MOSFET
- Tuned for the lowest R<sub>DS</sub> Q<sub>oss</sub> FOM
- 100 % R<sub>q</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



### **APPLICATIONS**

- · Primary side switch
- · Synchronous rectification
- DC/DC converter
- · Motor drive switch
- Boost converter
- LED backlighting



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8
Lead (Pb)-free and halogen-free	SiR4606DP-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	60	V	
Gate-source voltage		V <sub>GS</sub>	± 20	v	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		16 <sup>a</sup>		
	T <sub>C</sub> = 70 °C		16 <sup>a</sup>		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	10.5 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		8.4 <sup>b, c</sup>		
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	40	A	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		16 <sup>a</sup>		
	T <sub>A</sub> = 25 °C	ls	2.6 <sup>b, c</sup>		
Single pulse avalanche current	. 0.1!!	I <sub>AS</sub>	12		
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	7.2	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		31.2		
	T <sub>C</sub> = 70 °C		20	10/	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.7 b, c	W	
	T <sub>A</sub> = 70 °C		2.4 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150		
Soldering recommendations (peak temperature) d, e			260	°C	

#### Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. See solder profile (<a href="www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- f.  $T_C = 25 \, ^{\circ}C$

## Vishay Siliconix

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient a, b	t ≤ 10 s	R <sub>thJA</sub>	26	34	°C/W	
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	2.9	4	C/VV	

#### Notes

- a. Surface mounted on 1" x 1" FR4 board
- b. Maximum under steady state conditions is 70 °C/W

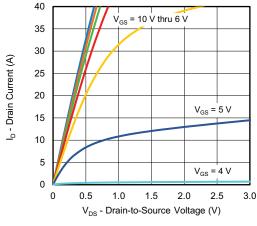
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	35	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \mu\text{A}$	-	-7.1	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2	-	4	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	100	nA	
Zero gate voltage drain current		V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V	-	-	1	μА	
	I <sub>DSS</sub>	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	10		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	10	-	-	Α	
Duta a successive state and the second	_ ` ′	$V_{GS} = 10 \text{ V}, I_D = 4 \text{ A}$ $V_{GS} = 7.5 \text{ V}, I_D = 4 \text{ A}$	-	0.0142	0.0185	Ω	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>		-	0.0166	0.0225		
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A	-	25	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	540	-	pF	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	150	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	11	-		
<del></del>		$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 4 \text{ A}$ $V_{DS} = 30 \text{ V}, V_{GS} = 7.5 \text{ V}, I_D = 4 \text{ A}$	-	8.9	13.5	nC	
Total gate charge	$Q_g$		-	6.9	10.5		
Gate-source charge	Q <sub>qs</sub>		-	2.5	-		
Gate-drain charge	Q <sub>qd</sub>		-	1.8	-		
Output charge	Q <sub>oss</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	-	9	-		
Gate resistance	Ra	f = 1 MHz	0.3	1.3	2.6	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	10	20		
Rise time	t <sub>r</sub>	$V_{DD} = 30 \text{ V}, R_1 = 7.5 \Omega, I_D \cong 4 \text{ A},$	-	5	10		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	14	30		
Fall time	t <sub>f</sub>		-	5	10		
Turn-on delay time	t <sub>d(on)</sub>		-	10	20	ns	
Rise time	t <sub>r</sub>	$V_{DD} = 30 \text{ V}, R_1 = 7.5 \Omega, I_D \cong 4 \text{ A},$	-	5	10	  - 	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 7.5 \text{ V}, R_q = 1 \Omega$	-	12	25		
Fall time	t <sub>f</sub>	•	-	5	10		
<b>Drain-Source Body Diode Characteristi</b>	cs		l.		l.	L	
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	16		
Pulse diode forward current	I <sub>SM</sub>	-	-	-	40	A	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 4 A, V <sub>GS</sub> = 0 V	-	0.85	1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	38	75	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>		-	23	45	nC	
Reverse recovery fall time	t <sub>a</sub>	$I_F = 4 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 °\text{C}$	-	17	-	ns	
Reverse recovery rise time	t <sub>b</sub>		_	21	_		

#### Notes

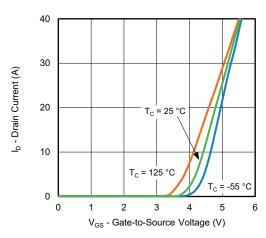
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

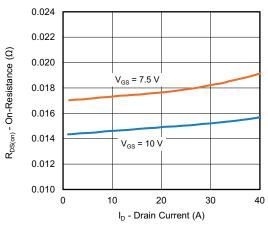




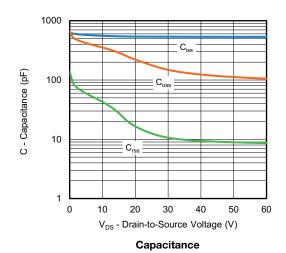
**Output Characteristics** 

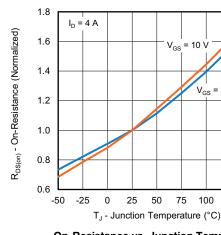


**Transfer Characteristics** 



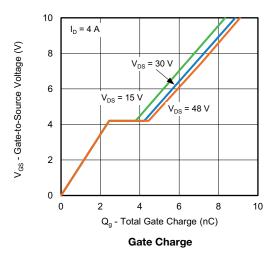
On-Resistance vs. Drain Current and Gate Voltage



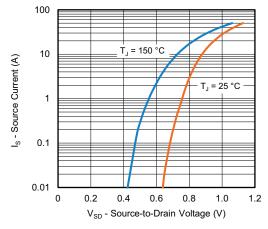


On-Resistance vs. Junction Temperature

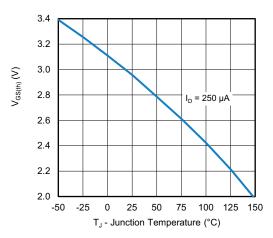
100 125



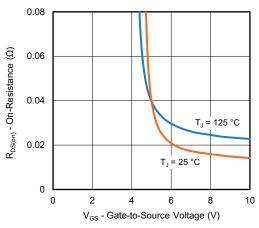




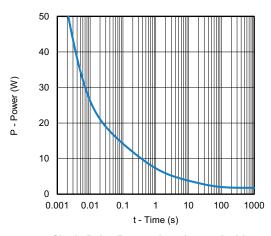
Source-Drain Diode Forward Voltage



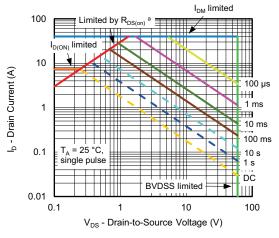
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage

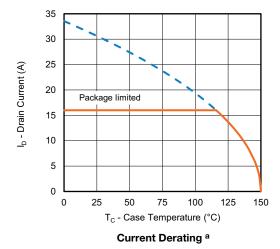


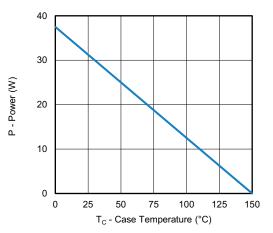
Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient





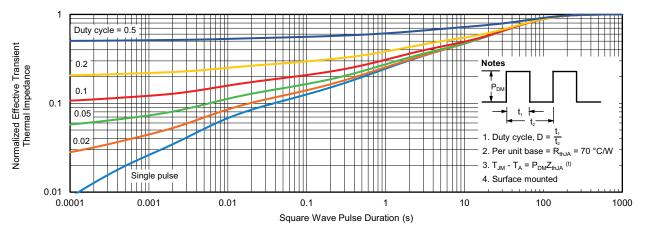


Power, Junction-to-Case

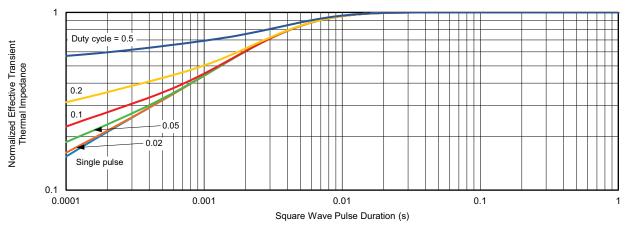
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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